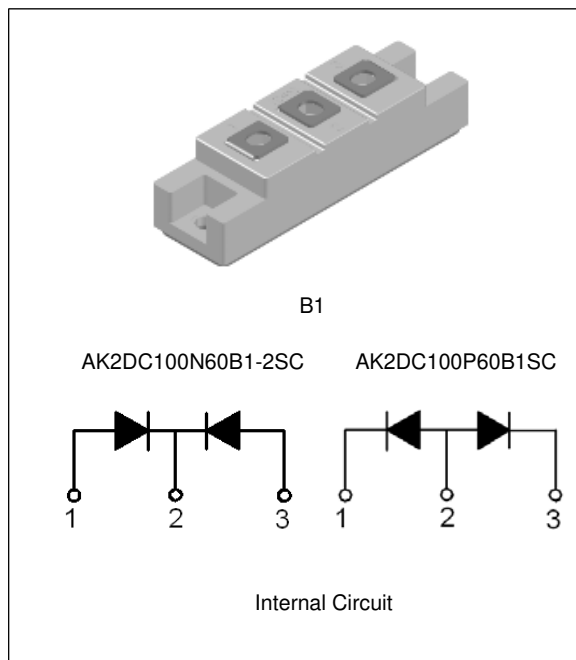


600V Isolation FRD Module

Description

The Fast Recovery Diode module devices are optimized to reduce losses and EMI/RFI in high frequency power conditioning electrical systems.

The Fast Recovery Diode module is ideally suited for power converters, inverter welders, motor drives and other applications where switching losses are significant portion of the total losses.



Features

- Repetitive Reverse Voltage: $V_{RRM} = 600V$
- Low Forward Voltage: $V_F(\text{typ.}) = 1.3V @ I_F=100A$
- Average Forward Current: $I_{F(AV)} = 100A @ T_C=100^\circ C$
- Reverse Recovery Time: $t_{rr}(\text{typ.}) = 140ns$
- Extensive Characterization of Recovery Parameters
- Reduced EMI and RFI
- Isolation Type Package
- $150^\circ C$ Operating Junction Temperature
- Built-in N/P-common Dual FRD Construction

Applications

- High Speed & High Power converters, Inverter Welders
- Various Switching and Telecommunication Power Supply
- Cutting Machine

Absolute Maximum Ratings ($T_C=25^\circ C$, unless otherwise noted)

Symbol	Parameter			Ratings	Unit
V _{RRM}	Repetitive Peak Reverse Voltage			600	V
V _R	DC Blocking Voltage			480	V
I _{F(AV)}	Average Rectified Forward Current	Per Diode	T _C = 25℃	200	A
			T _C = 100℃	100	
		Per Package	T _C = 25℃	400	
			T _C = 100℃	200	
I _{FSM}	Non-repetitive Peak Surge Current (Per Diode) 60Hz Single Half-sine Wave			1750	A
I ² t	I ² t For Fusing 60Hz Sine Wave			12.7 * 10 ³	A²S
P _D	Maximum Power Dissipation			390	W
V _{iso}	Isolation Voltage @AC 1 Minutes			2500	V
T _J	Junction Temperature			-55 ~ +150	℃
T _{STG}	Storage Temperature Range			-55 ~ +150	℃
	Mounting Torque (M6)			4.0	N.m
	Terminal Torque (M6)			2.0	N.m
	Weight			112	g

Electrical Characteristics (Per Diode, $T_C=25\text{ }^{\circ}\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_F	Forward Voltage Drop	$I_F=100\text{A}$	-	1.3	1.6	V
		$I_F=100\text{A}$, $T_C=100^{\circ}\text{C}$	-	1.1	-	V
I_{RM}	Reverse Leakage Current	$V_R=600\text{V}$	-	-	0.5	mA
		$V_R=600\text{V}$, $T_C=100^{\circ}\text{C}$	-	-	1	mA
t_{rr}	Reverse Recovery Time	$I_F=1\text{A}$, $di/dt=-200\text{A/us}$	-	35	-	ns
t_{rr}	Reverse Recovery Time	$I_F=100\text{A}$, $di/dt=-200\text{A/us}$	-	100	140	ns
I_{rr}	Reverse Recovery Current		-	9.0	-	A
t_{rr}	Reverse Recovery Time	$I_F=100\text{A}$, $di/dt=-200\text{A/us}$, $T_C=100^{\circ}\text{C}$	-	220	-	ns
I_{rr}	Reverse Recovery Current		-	20.0	-	A

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{th(J-C)}$	Thermal Resistance, Junction to case	0.32	$^{\circ}\text{C/W}$
$R_{th(C-A)}$	Thermal Resistance, Case to Ambient	40	$^{\circ}\text{C/W}$

Typical Performance Characteristics

Fig. 1. Typical Characteristics: V_F vs. I_F

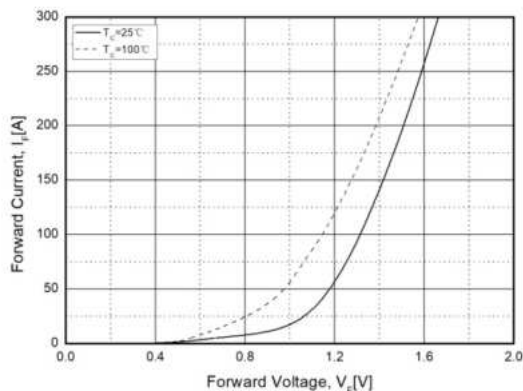


Fig. 2. Typical Reverse Recovery Time vs. di/dt

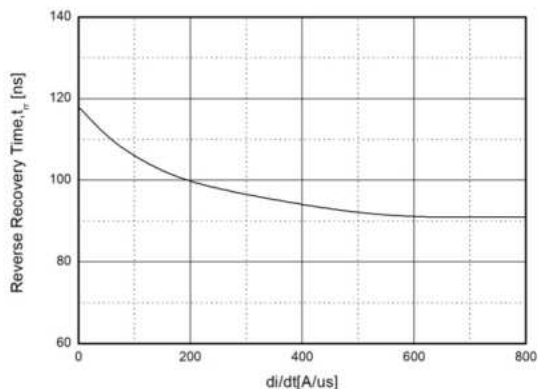


Fig. 3. Transient Thermal Impedance Characteristics ($R_{th(J-C)}$)

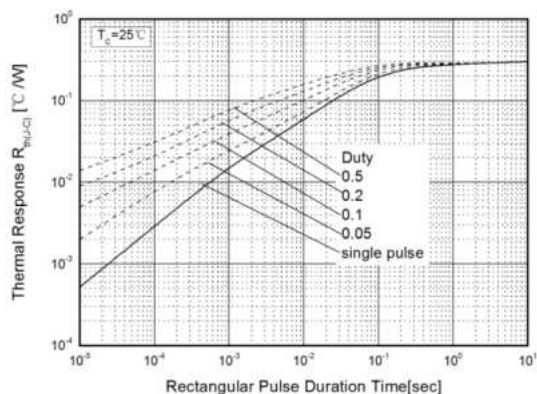
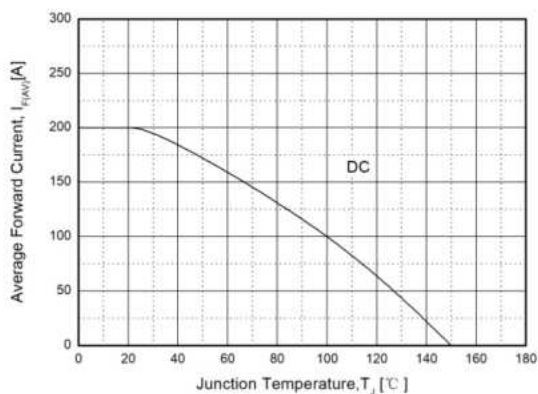
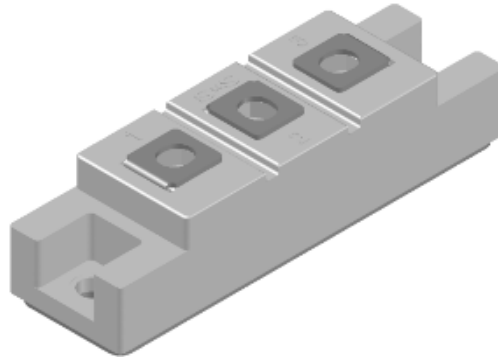


Fig. 4. Forward Current Derating Curve



Package Dimensions

B1



(Dimensions in Millimeters)

